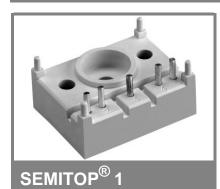
SK 25 GAL 063



IGBT Module

SK 25 GAR 063 SK 25 GAL 063

Preliminary Data

Features

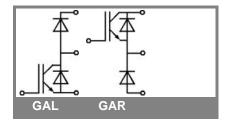
- Compact design
- · One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- N-channel homogeneous silicon structure (NPT-Non punch-through IGBT)
- · High short circuit capability
- Low tail current with low temperature dependence
- UL recognized, file no. E 63 532

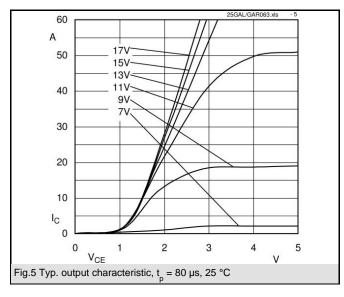
Typical Applications

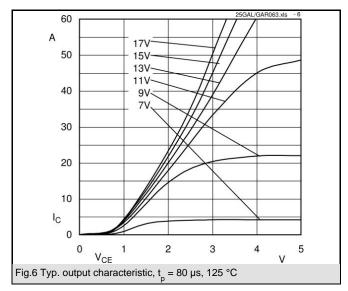
- Switching (not for linear use)
- Driver
- Switched mode power supplies
- UPS

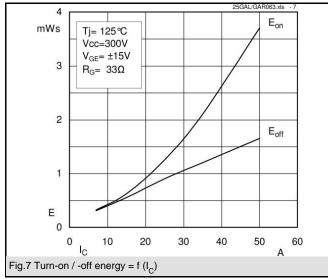
Absolute	Maximum Ratings	T _s = 25 °C, unless otherwise	T _s = 25 °C, unless otherwise specified					
Symbol	Conditions	Values	Units					
IGBT								
V_{CES}		600	V					
V_{GES}		± 20	V					
I _C	T _s = 25 (80) °C;	30 (21)	Α					
I _{CM}	$t_p < 1 \text{ ms; } T_s = 25 (80) \text{ °C;}$	60 (42)	Α					
T_{j}		- 40 + 150	°C					
Freewheeling CAL diode								
I _F	T _s = 25 (80) °C;	36 (24)	Α					
$I_{FM} = -I_{CM}$	$t_p < 1 \text{ ms}; T_s = 25 (80) ^{\circ}\text{C};$	72 (48)	Α					
T_j		- 40 + 150	°C					
T _{stg}		- 40 + 125	°C					
T _{sol}	Terminals, 10 s	260	°C					
V_{isol}	AC 50 Hz, r.m.s. 1 min. / 1 s	2500 / 3000	V					

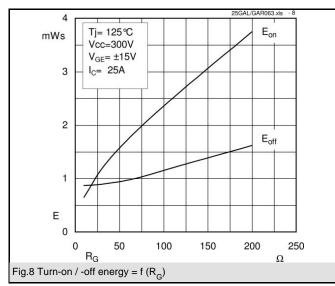
Characte	ristics	T _o = 25 °C	$\Gamma_s = 25 ^{\circ}\text{C}$, unless otherwise specified			
	Conditions	min.	typ.	max.	Units	
IGBT	Conditions	111111.	ιyp.	IIIax.	Units	
V _{CE(sat)} V _{GE(th)} C _{ies} R _{th(j-s)}	I_{C} = 20 A, T_{j} = 25 (125) °C V_{CE} = V_{GE} ; I_{C} = A V_{CE} = 25 V; V_{GE} = 0 V; 1 MHz per IGBT per module	4,5	1,8 (1,9) 5,5 1,6	2,2 (2,4) 6,5 1,4	V V nF K/W K/W	
$t_{d(on)}$ t_r $t_{d(off)}$ t_f $E_{on} + E_{off}$	under following conditions: $V_{CC} = 300 \text{ V}, V_{GE} = \pm 15 \text{ V}$ $I_{C} = 25 \text{ A}, T_{J} = 125 \text{ °C}$ $R_{Gon} = R_{Goff} = 33 \Omega$ Inductive load		30 35 200 25 2,15		ns ns ns ns mJ	
	eling CAL diode					
$V_{F} = V_{EC}$ $V_{(TO)}$ r_{T} $R_{th(j-s)}$	I _F = 25 A; T _j = 25 (125) °C T _j = 125 °C T _j = 125 () °C		1,45 (1,4) 0,85 22	1,7 (1,75) 0,9 32 1,7	V V mΩ K/W	
I _{RRM} Q _{rr} E _{off}	under following conditions: $I_F = 25 \text{ A}; V_R = 300 \text{ V}$ $dI_F/dt = -500 \text{ A/}\mu\text{s}$ $V_{GE} = 0 \text{ V}; T_j = 125 ^{\circ}\text{C}$		16 2 0,25		Α μC mJ	
Mechanic	cal data	•			•	
M1	mounting torque			1,5	Nm	
w			13		g	
Case	SEMITOP® 1		Т3			

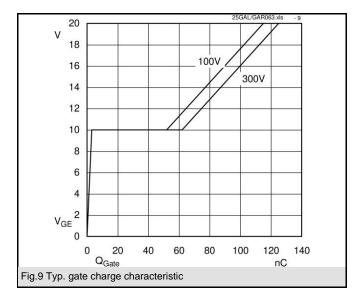


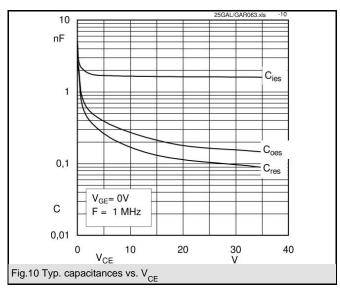




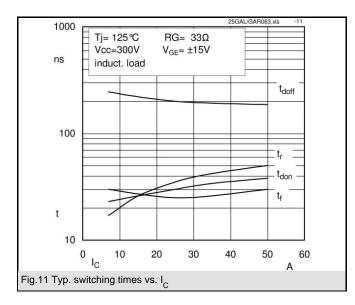


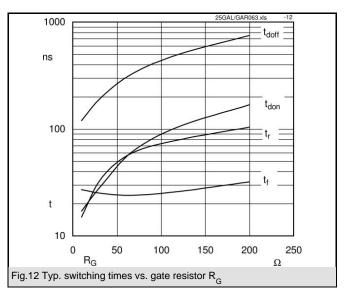


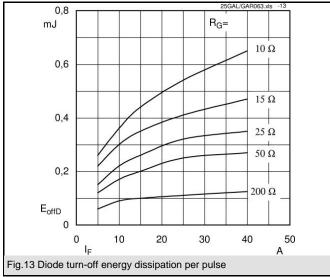




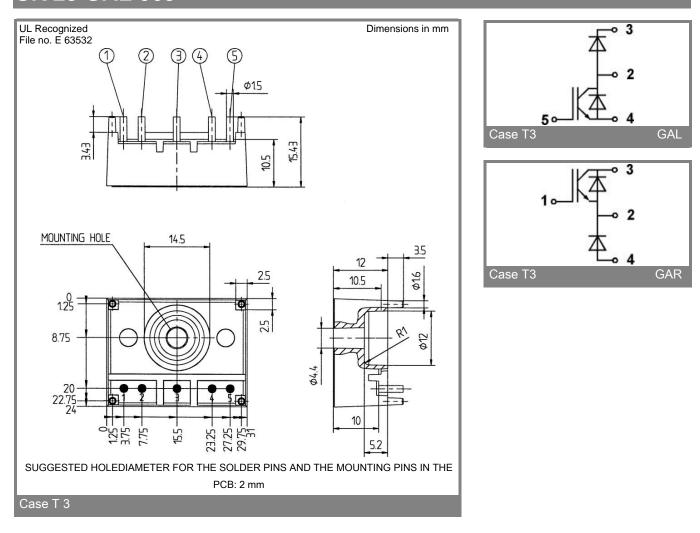
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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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